INTEGRATED CIRCUITS

DATA SHEET

CBT16211

24-bit bus switch with 12-bit output enables

Product data 2001 Jun 13





24-bit bus switch with 12-bit output enables

CBT16211

FEATURES

- 5 Ω switch connection between two ports
- TTL compatible control input levels
- Package options include plastic shrink small outline (SSOP), thin shrink small outline (TSSOP)
- ESD protection exceeds 1000 V CDM per JESD22-C101
- Latch-up testing is done to JESDEC Standard JESD78 which exceeds 100 mA

DESCRIPTION

The CBT16211 provides 24 bits of high-speed TTL-compatible bus switching. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The device is organized as a dual 12-bit bus switch with separate output-enable (\overline{OE}) inputs. It can be used as two 12-bit bus switches or as one 24-bit bus switch. When \overline{OE} is low, the associated 12-bit bus switch is on, and port A is connected to port B. When \overline{OE} is high, the switch is open, and a high-impedance state exists between the ports.

The CBT16211 is characterized for operation from -40 to 85 °C.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25 °C; GND = 0 V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay An to Yn	C _L = 50 pF; V _{CC} = 5 V	0.25	ns
C _{IN}	Input capacitance	V _I = 0 V or V _{CC}	4.3	pF
C _{OUT}	Output capacitance	Outputs disabled; $V_O = 0 \text{ V or } V_{CC}$	6.9	pF
Icc	Total supply current	Outputs disabled; V _{CC} = 5.5 V	3.0	μΑ

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
56-Pin Plastic SSOP Type III	−40 to 85 °C	CBT16211DL	SOT371-1
56-Pin Plastic TSSOP Type II	–40 to 85 °C	CBT16211DGG	SOT364-1

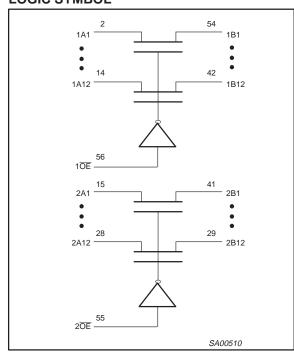
FUNCTION TABLE

INP	UTS	OUTPUTS				
10E	2 OE	1A, 1B	2A, 2B			
L	L	1A = 1B	2A = 2B			
L	Н	1A = 1B	Z			
н	L	Z	2A = 2B			
н	Н	Z	Z			

H = High voltage level L = Low voltage level

Z = High impedance "off" state

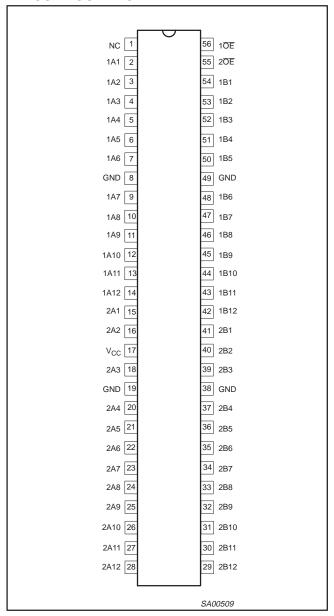
LOGIC SYMBOL



24-bit bus switch with 12-bit output enables

CBT16211

PIN CONFIGURATION



PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	NC	No internal connection
56, 55	10E, 20E	Output Enables
2, 3, 4, 5, 6, 7, 9, 10, 11, 12, 13, 14	1A1-1A12	Inputs
54, 53, 52, 51, 50, 48, 47, 46, 45, 44, 43, 42	1B1-1B12	Outputs
15, 16, 18, 20, 21, 22, 23, 24, 25, 26, 27, 28	2A1-2A12	Inputs
41, 40, 39, 37, 36, 35, 34, 33, 32, 31, 30, 29	2B1-2B12	Outputs
8, 19, 38, 49	GND	Ground (0 V)
17	V _{CC}	Positive supply voltage

2001 Jun 13 3

24-bit bus switch with 12-bit output enables

CBT16211

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC input diode current	V _I < 0	- 50	mA
V _I	DC input voltage ³		-0.5 to +7.0	V
V _{OUT}	DC output voltage ³	output in Off or High state	-0.5 to +5.5	V
I _{OUT}	DC output current	output in Low state	128	mA
T _{stg}	Storage temperature range		-65 to 150	°C

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the
 device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to
 absolute-maximum-rated conditions for extended periods may affect device reliability.
- 2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.
- 3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
STINIBUL	PARAMETER	Min	Max	UNII
V _{CC}	DC supply voltage	4.5	5.5	V
V_{IH}	High-level input voltage	2.0	_	V
V_{IL}	Low-level Input voltage	_	0.8	V
T _{amb}	Operating free-air temperature range	-40	+85	°C

DC ELECTRICAL CHARACTERISTICS

				LIMITS				
SYMBOL	PARAMETER	TEST CONDITIONS	T _{amb}	T _{amb} = −40 to +85 °C				
			Min	Typ ¹	Max	1		
V _{IK}	Input clamp voltage	$V_{CC} = 4.5 \text{ V}; I_{I} = -18 \text{ mA}$	_	_	-1.2	V		
V _P	Output high pass voltage	$V_{IN} = V_{CC} = 5.0 \text{ V}; I_{OUT} = -100 \mu\text{A}$	3.4	3.6	3.9	V		
	lanut la akama aurrant	V _{CC} = 0 V; V _I = 5.5 V		_	10			
t ₁	Input leakage current	V _{CC} = 5.5 V; V _I = GND or 5.5 V	_	_	±1	μΑ		
Icc	Quiescent supply current	$V_{CC} = 5.5 \text{ V}; I_{O} = 0, V_{I} = V_{CC} \text{ or GND}$	_	_	3	μΑ		
Δl _{CC}	Additional supply current per input pin ²	V_{CC} = 5.5 V, one input at 3.4 V, other inputs at V_{CC} or GND		_	2.5	mA		
C _I	Control pins	V _I = 3 V or 0	T -	4.5	_	pF		
C _{I(OFF)}	Port OFF capacitance	$V_O = 3 \text{ V or } 0, \overline{OE} = V_{CC}$	T -	6.9	_	pF		
		$V_{CC} = 4.0 \text{ V}; V_1 = 2.4 \text{ V}; I_1 = 15 \text{ mA}$	T -	14	20			
r _{on} 3		$V_{CC} = 4.5 \text{ V}; V_1 = 0 \text{ V}; I_1 = 64 \text{ mA}$	T -	5	7	Ω		
Ion		$V_{CC} = 4.5 \text{ V}; V_1 = 0 \text{ V}; I_1 = 30 \text{ mA}$	_	5	7] 💃		
		$V_{CC} = 4.5 \text{ V}; V_1 = 2.4 \text{ V}; I_1 = -15 \text{ mA}$	_	8	12			

NOTES

- 1. All typical values are at V_{CC} = 5 V, T_{amb} = 25 °C.
- 2. This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.
- Measured by the voltage drop between the A and the B terminals at the indicated current through the switch. On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

2001 Jun 13

24-bit bus switch with 12-bit output enables

CBT16211

AC CHARACTERISTICS

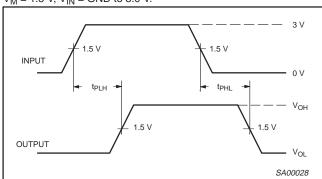
 $GND = 0 V; t_{R;} C_{L} = 50 pF$

SYMBOL	PARAMETER	FROM	то	V _{CC} = 5.0	UNIT	
STWIBUL	PARAMETER	(INPUT)	(OUTPUT)	Min	Max	ONII
t _{pd}	Propagation delay ¹	A or B	B or A	_	0.25	ns
t _{en}	Output enable time to High and Low level	ŌĒ	A or B	1.5	6.0	ns
t _{dis}	Output disable time from High and Low level	ŌĒ	A or B	1.5	6.0	ns

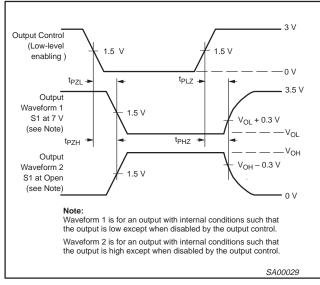
NOTE:

AC WAVEFORMS

 $V_{M} = 1.5 \text{ V}, V_{IN} = \text{GND to } 3.0 \text{ V}.$

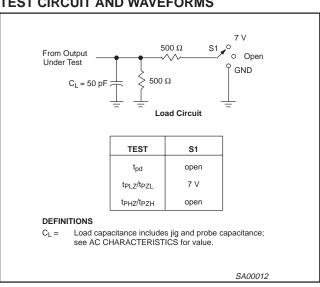


Waveform 1. Input (An) to Output (Yn) Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORMS



2001 Jun 13

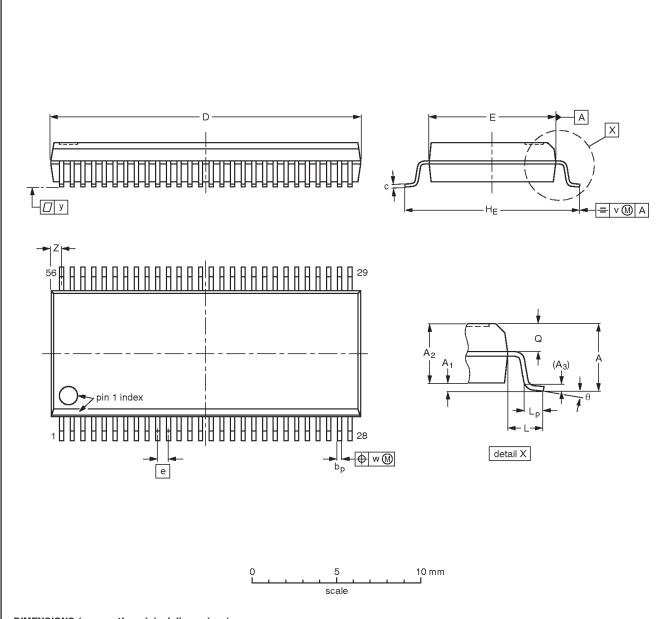
^{1.} This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

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CBT16211

SSOP56: plastic shrink small outline package; 56 leads; body width 7.5 mm

SOT371-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	18.55 18.30	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1330E DATE
SOT371-1		MO-118			95-02-04 99-12-27

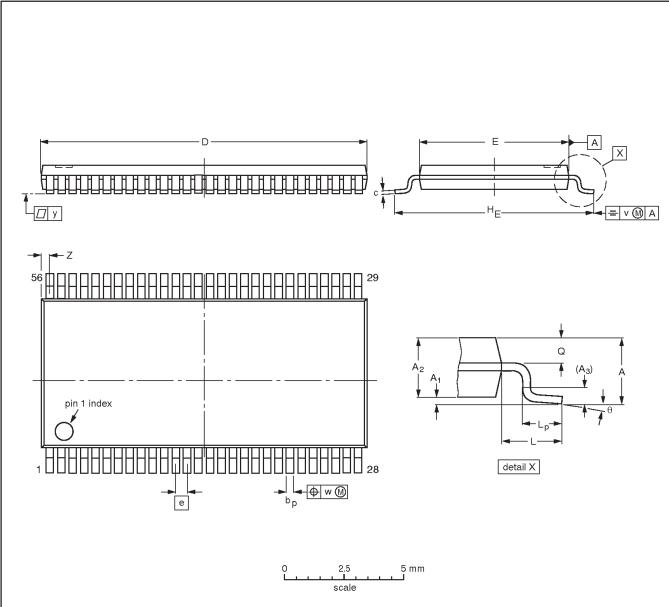
2001 Jun 13 6

24-bit bus switch with 12-bit output enables

CBT16211

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1



DIMENSIONS (mm are the original dimensions).

UNIT	A max.	Α1	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	٧	w	у	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1.0	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES		EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1990E DATE
SOT364-1		MO-153				-95-02-10- 99-12-27

2001 Jun 13 7

24-bit bus switch with 12-bit output enables

CBT16211

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Data sheet status ^[1]	Product status ^[2]	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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